

PATENT  
6353/P1/LOWK/JW

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Hongwen Li et al.  
Serial No. : 10/759,801  
Filed : January 16, 2004  
For : INTEGRATED EQUIPMENT SET FOR FORMING A LOW K  
DIELECTRIC INTERCONNECT ON A SUBSTRATE  
Examiner : Rudy Zervigon  
Group Art Unit : 1763  
Customer No. : 41161

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

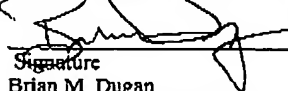
Sir:

In response to the Office Action dated January 25,  
2006, please amend the above-captioned application as follows:

Amendments to the Claims begin on page 2 of this  
paper.

Remarks begin on page 4 of this paper.

Certificate of Mailing/Transmission (37 C.F.R. Section 1.8(a))  
I hereby certify that, on the date shown below, this correspondence is being:  
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